

## DECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

		ING CIRCUIT, IMAGE SEN				
the specificati	on of which (chec	k one); 🛘 is attached s Application Serial N	hereto: X was fil	ed on <u>February</u>	23, 20	004
through)		(if applicable). I	hereby state that	I have reviewed and	underst	and the
contents of the	above-identified	specification, includ	ling the claims, as	amended by any amend	ment(s)	
referred to abo	ve. I acknowledg	e the duty to disclose of Federal Regulations,	information which	is material to pater v claim foreign pric	rity be	y in nefits
under Title 35,	United States Co	de, §119 of any foreig	n application(s) fo	r patent or inventor	's cert	ificate
having a filing	date before that	of the application or	which priority is	claimed.		
Prior F	oreign Applicatio	n(s)			· • • •	1.74
2007 - 0/0577	IADAN	26 02 2003		Pri	iority C X	Laimed
2003-049573 (Number)	JAPAN (Country)	26 02 2003 (Day/Month/Year F	iled)		Yes	No
(	(000.11.7)	(52), 110.10.1, 102.				_
2003-049574	JAPAN	26 02 2003		<del>_</del>	<b>X</b>	
(Number)	(Country)	(Day/Month/Year f	iled)		Yes	No
2003-149268	JAPAN	27 05 2003			х	
(Number)	(Country)	(Day/Month/Year F	iled)		Yes	No
						_
2004-023097	JAPAN	30 01 2004	21 - 45		X Yes	□ No
(Number)	(Country)	(Day/Month/Year F	ilea)		162	NU
			_			
(Number)	(Country)	(Day/Month/Year F	iled)		Yes	No
(Number)	(Country)	(Day/Month/Year F	iled)		Yes	No
·	•	•				
		fit under Title 35, Uni				tion is
		insofar as the subject d States application i				
not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to						
patentability a	s defined in Titl	e 37, Code of Federal tion and the national	Regulations, §1.56(	a) which occurred be	tween ti	he cetion:
TILING Gate of	the prior applica	tion and the national	or PCI Internationa	t fitting date of this	s appri	Cat ron.
(Application Se	rial No )	(Filing Date)	(Statu	s - Patented, Pendir	g or Ab	andoned)
CAPPETCULTON DO		triting bate,	(01212	, , , , , , , , , , , , , , , , , , , ,	•	•
(Application Se	rial No.)	(Filing Date)	(Statu	s - Patented, Pendin	g or Ab	andoned)
	·					
I hereb	w declare that al	l statements made here	in of my oun knowle	dae are true and the	at all	
statements made	on information a	nd belief are believed	to be true; and fu	rther that these sta	tements	were
made with the knowledge that willful false statements and the like so made are punishable by fine or						
imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.						
	,					
		POWER_OF	ATTORNEY			
I (we)	hereby appoint Br	uce L. Adams, Registra	tion No. 25,386, Va	n C. Wilks, Registra	ation No	. 25,027
and Franco S. D.	e Liquori. Regist	ration No. 36.497 whos	e post office addre	ss ís: Adams & Wilks	., 50 Br	oadway,
31st Floor, New	York, New York 1	0004, as my (our) atto nd to transact all bus	rneys with full pow	er of substitution a States Patent and T	na revo	k Office
connected there		na to transact att bac	111000 111 1110 0111 101			
Full Name of Fi	rst or Sole Inven	tor	Citizenship			
Satoshi MACHIDA			JAPAN			
SELOSNI MACHIDA			JAPAN			•
RESIDENCE Addre			POST OFFICE Addre	ss - Street		
8, Nakase 1-cho			same as residence	address		
City (7in)			City (Zip)	<u> </u>		
City (Zip)		4	city (Zip)			
Chiba-shi, Chib	a 261-8507					
State or Countr		·	State or Country			
			·			
JAPAN						
Date		<del></del> -	Signature /			
,			•			
April 21, 2	004		0 / 1	0 0 1		
			& lashi	machida		
				1, 0,0 , , ,		

See second page for additional joint inventors.